

# **Product Compliance Declaration**

Please see <u>www.molex.com</u> for the most up-to-date information.

Contact Information					
Name	Molex Product Compliance	E-Mail	Product.Compliance@molex.com		
Part Inform	ation				
Part Number	0346910161	Part Weight	7.534G		
Part Name	STAC64 RA HDR 16 CKT GRY POL B TRAY				

## **Product Composition**

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
STAC64 RA HDR 16 CKT GRY POL B TRAY	Assembly		100	7.534
STAC64 RA HDR HOUSING 16 CKT GRY POL B	Component		75.5774	5.694
PS-ST GF30	Material		75.5774	5.694
PS-ST	Substance		44.3545	3.341666
GF-Fibre	Substance		22.5787	1.701082
Pigment portion, not to declare	Substance	system	0.9258	0.069752
Benzene, ethenyl-, polymer with 1,3-butadiene, hydrogenated	Substance	66070-58-4	5.144	0.387551
Further Additives, not to declare	Substance	system	2.5743	0.193949
0.64 X 34.93 SQ PIN BRASS REFLOW SN	Component		13.2732	1
SQ WIRE C26000 PL 0.625 X 0.625	Material		13.2732	1
Cartridge Brass 70% Unplated	Material		13.0005	0.97946
Copper	Substance	7440-50-8	9.1004	0.685622
Zinc (metal)	Substance	7440-66-6	3.9002	0.293838

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Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Copper Plating	Material		0.026	0.001962
Copper	Substance	7440-50-8	0.026	0.001962
Tin Plating	Material		0.1424	0.010729
Tin	Substance	7440-31-5	0.1424	0.010729
Nickel Plating	Material		0.1042	0.007849
Nickel	Substance	7440-02-0	0.1042	0.007848
Further Additives, not to declare	Substance	system	1E-05	8E-07
0.64 X 29.86 SQ PIN BRASS REFLOW SN	Component		10.5123	0.792
SQ WIRE C26000 PL 0.625 X 0.625	Material		10.5123	0.792
Cartridge Brass 70% Unplated	Material		10.2964	0.775732
Copper	Substance	7440-50-8	7.2075	0.543013
Zinc (metal)	Substance	7440-66-6	3.0889	0.23272
Copper Plating	Material		0.0206	0.001554
Copper	Substance	7440-50-8	0.0206	0.001554
Tin Plating	Material		0.1128	0.008497
Tin	Substance	7440-31-5	0.1128	0.008497
Nickel Plating	Material		0.0825	0.006216
Nickel	Substance	7440-02-0	0.0825	0.006216
Further Additives, not to declare	Substance	system	8E-06	6E-07
PIN ALIGNMENT PLATE-16CKT STAC64	Component		0.6371	0.048
PET ST MYLAR 0.25 X 26.86	Material		0.6371	0.048
Polyethylene terephthalate	Substance	25038-59-9	0.6199	0.046704
Further Additives, not to declare	Substance	system	0.0172	0.001296

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## **ROHS** Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

#### **Contained Substances Exceeding Threshold**

None

#### Exemptions

None

## **REACH-SVHC** Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

## **Contained Substances Exceeding Threshold**

None

# **GADSL** Declaration Information

Regulatory Revision GADSL imported from IMDS

## **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	150	Yes
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes
copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes
copper	e-plate Cu (electrodeposited Copper Coatings)	*Note	999,625	Yes
glass, oxide, chemicals	PS-ST GF30	*Note	320,000	Yes

#### \*Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Part Name

Exemption

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#### Exemptions

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/ cm2/week)

# **HFLH Declaration Information**

Regulatory Revision IEC 61249-2-21

## **Contained Substances Exceeding Threshold**

None

# **China ROHS Declaration Information**

Part Number 034691016 Part Name STAC64 RA TRAY	1 A HDR 16 CKT GRY POL B						
			Haz	zardous S	Substance	s	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
STAC64 RA HDR 16 CKT GRY POL B TRAY		0	0	0	О	0	0
STAC64 RA HDR HOUSING 16 CKT GRY POL B		0	0	0	0	0	0
0.64 X 34.93 SQ PIN BRASS REFLOW SN		0	0	0	0	0	0
0.64 X 29.86 SQ PIN BRASS REFLOW SN		0	0	0	0	0	0
PIN ALIGNMENT PLATE-16CKT STAC64		0	0	0	0	0	0

## **Process Information**

Component Plating / Surface Finish	MSn-RNi
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	WAVE

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Maximum Exposure Time (seconds)	040
Maximum Process Temperature (C)	260
Maximum Cycles at Reflow Temperature	003
J-STD-020 Moisture Sensitivity Level	N/A

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